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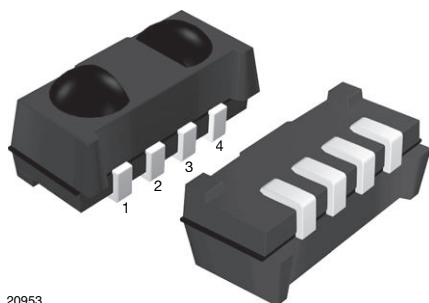
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





IR Receiver Modules for Remote Control Systems



20953

MECHANICAL DATA

Pinning:

1, 4 = GND, 2 = V_S , 3 = OUT

FEATURES

- Very low supply current
- Photo detector and preamplifier in one package
- Internal filter for 38 kHz IR signals
- Supply voltage: 2.7 V to 5.5 V
- Improved immunity against ambient light
- Capable of side or top view
- Insensitive to supply voltage ripple and noise
- Two lenses for high sensitivity and wide receiving angle
- Narrow optical filter to reduce interference from plasma TV emissions
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



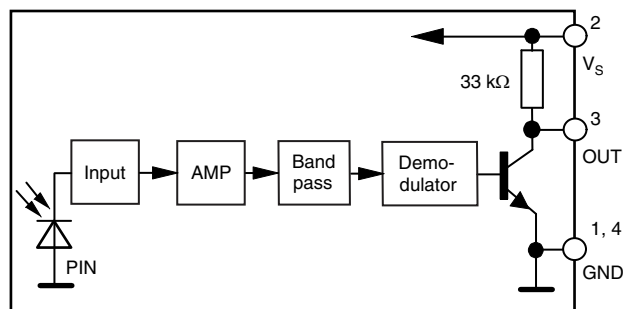
DESCRIPTION

The TSOP77038 is a compact two lens SMD IR receiver for sensor applications. It has a high gain for IR signals at 38 kHz. The detection level does not change when ambient light or strong IR signals are applied. It can receive continuous 38 kHz signals or 38 kHz bursts.

This component has not been qualified according to automotive specifications.

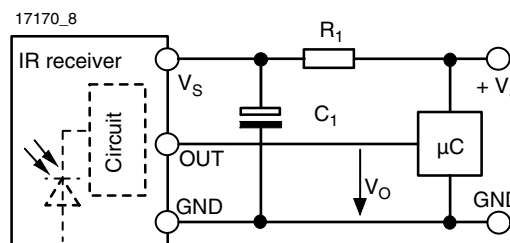
PARTS TABLE	
CARRIER FREQUENCY	SENSOR APPLICATIONS
38 kHz	TSOP77038

BLOCK DIAGRAM



16833_17

APPLICATION CIRCUIT



The external components R_1 and C_1 are optional to improve the robustness against electrical overstress (typical values are $R_1 = 100 \Omega$, $C_1 = 0.1 \mu F$). The output voltage V_O should not be pulled down to a level below 1 V by the external circuit. The capacitive load at the output should be less than 2 nF.



ABSOLUTE MAXIMUM RATINGS				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage		V_S	- 0.3 to + 6	V
Supply current		I_S	5	mA
Output voltage		V_O	- 0.3 to ($V_S + 0.3$)	V
Output current		I_O	5	mA
Junction temperature		T_j	100	°C
Storage temperature range		T_{stg}	- 25 to + 85	°C
Operating temperature range		T_{amb}	- 25 to + 85	°C
Power consumption	$T_{amb} \leq 85\text{ °C}$	P_{tot}	10	mW

Note

- Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability.

ELECTRICAL AND OPTICAL CHARACTERISTICS ($T_{amb} = 25\text{ °C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply current	$E_v = 0, V_S = 5\text{ V}$	I_{SD}	0.65	0.85	1.05	mA
	$E_v = 40\text{ klx, sunlight}$	I_{SH}		0.95		mA
Supply voltage		V_S	2.7		5.5	V
Transmission distance	$E_v = 0$, test signal see fig. 1, IR diode TSAL6200, $I_F = 400\text{ mA}$	d		40		m
Output voltage low	$I_{OSL} = 0.5\text{ mA}$, $E_e = 0.7\text{ mW/m}^2$, test signal see fig. 1	V_{OSL}			100	mV
Minimum irradiance	Pulse width tolerance: $t_{pi} - 5/f_o < t_{po} < t_{pi} + 6/f_o$, test signal see fig. 1	$E_e\text{ min.}$		0.5	1	mW/m^2
Maximum irradiance	$t_{pi} - 5/f_o < t_{po} < t_{pi} + 6/f_o$, test signal see fig. 1	$E_e\text{ max.}$	30			W/m^2
Directivity	Angle of half transmission distance	$\phi_{1/2}$		± 50		deg

TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ °C}$, unless otherwise specified)

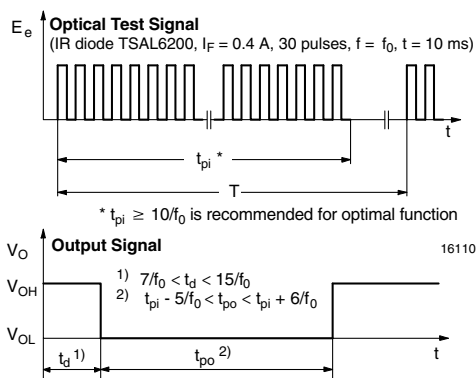


Fig. 1 - Output Active Low

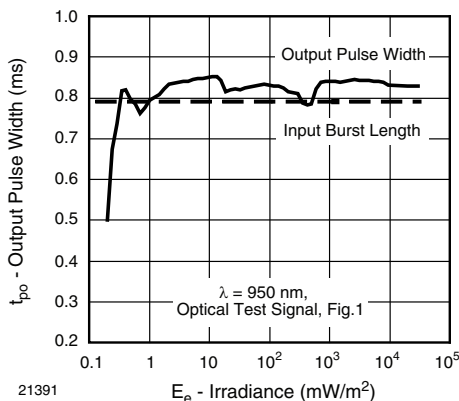


Fig. 2 - Pulse Length and Sensitivity in Dark Ambient

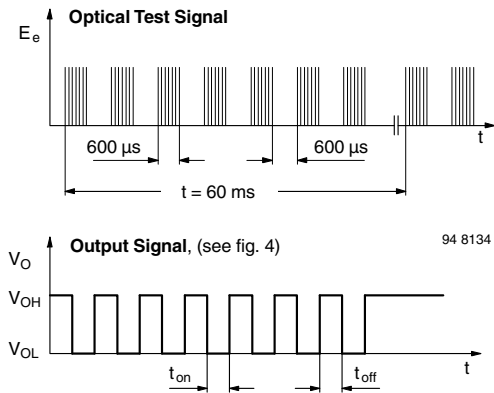
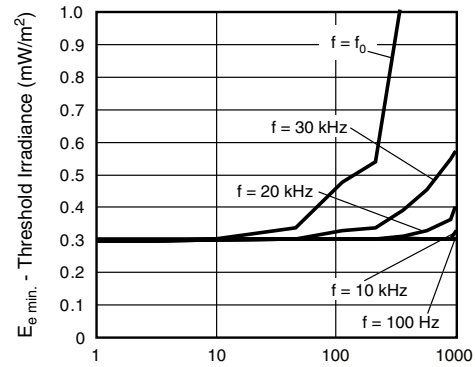
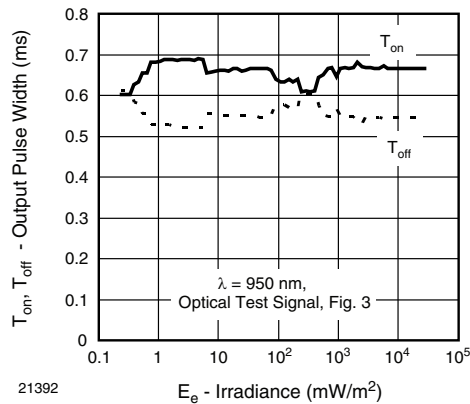


Fig. 3 - Output Function



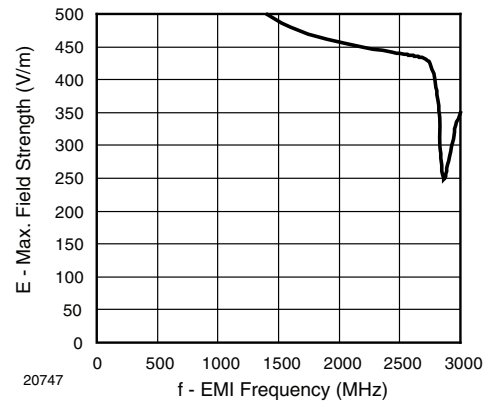
21394 ΔV_{sRMS} - AC Voltage on DC Supply Voltage (mV)

Fig. 6 - Sensitivity vs. Supply Voltage Disturbances



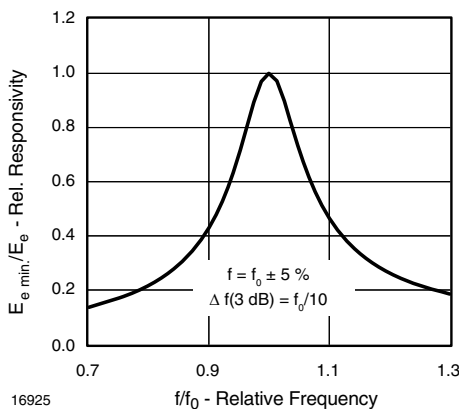
21392

Fig. 4 - Output Pulse Diagram



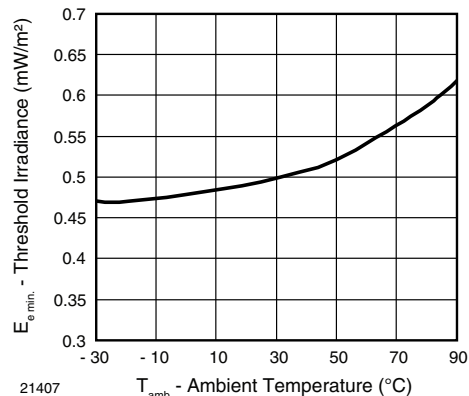
20747

Fig. 7 - Sensitivity vs. Electric Field Disturbances



16925

Fig. 5 - Frequency Dependence of Responsivity



21407

Fig. 8 - Sensitivity vs. Ambient Temperature

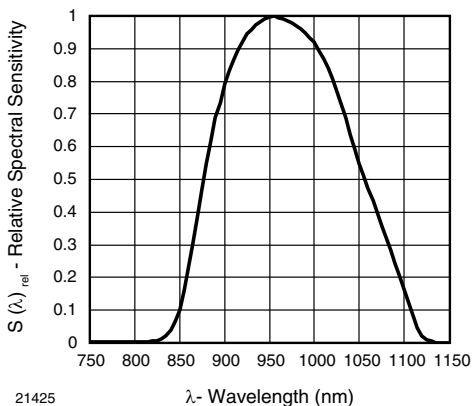


Fig. 9 - Relative Spectral Sensitivity vs. Wavelength

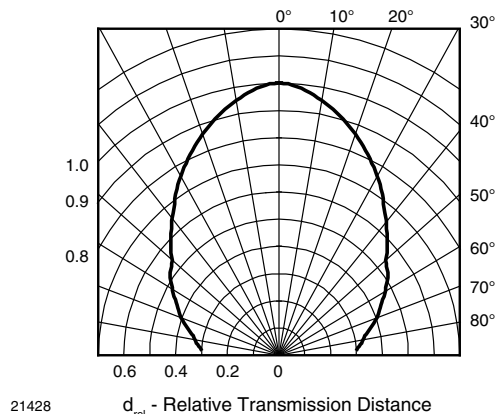


Fig. 11 - Vertical Directivity

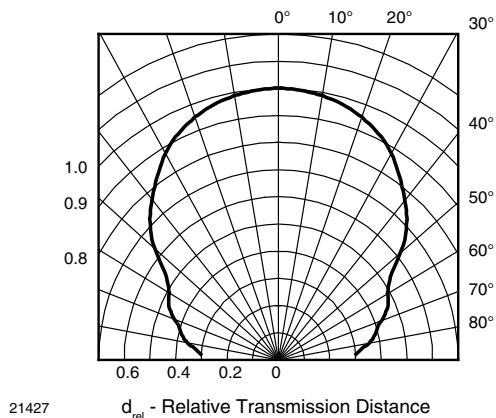


Fig. 10 - Horizontal Directivity

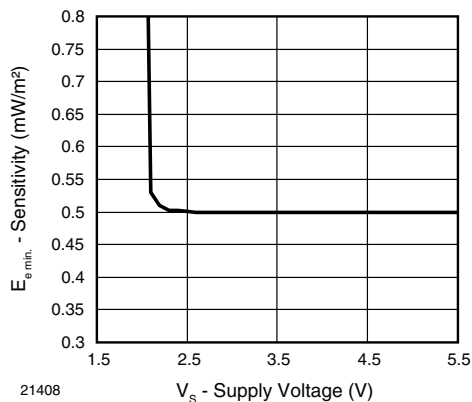
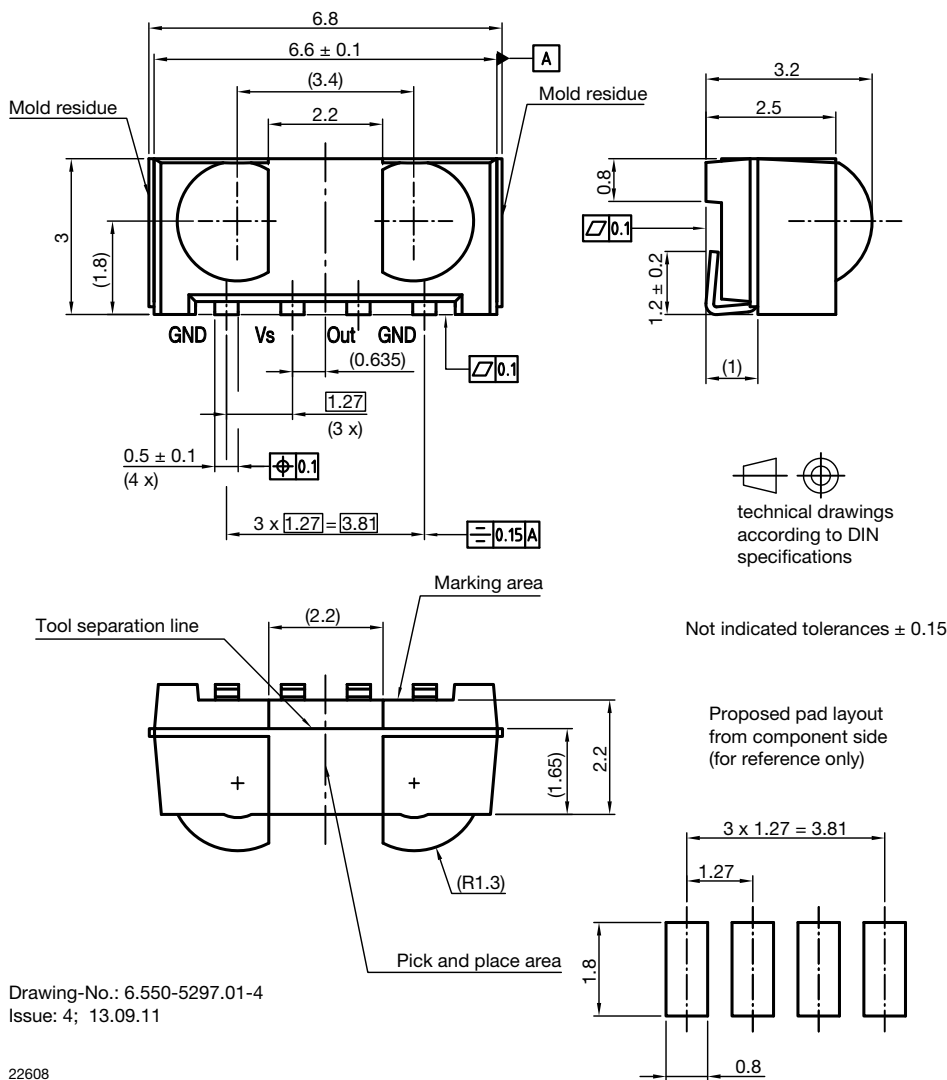


Fig. 12 - Sensitivity vs. Supply Voltage



PACKAGE DIMENSIONS in millimeters



Drawing-No.: 6.550-5297.01-4
Issue: 4; 13.09.11

22608

ASSEMBLY INSTRUCTIONS

Reflow Soldering

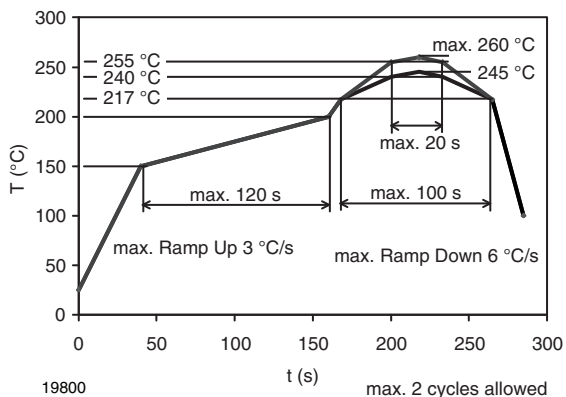
- Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

Manual Soldering

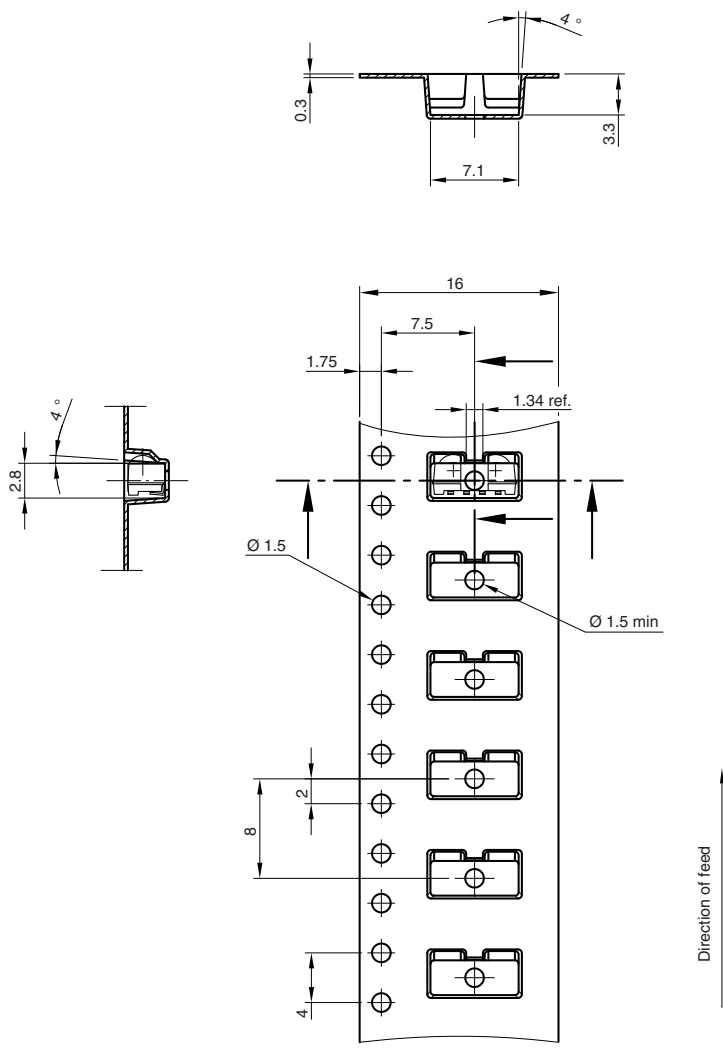
- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- Handle products only after the temperature has cooled off



VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE



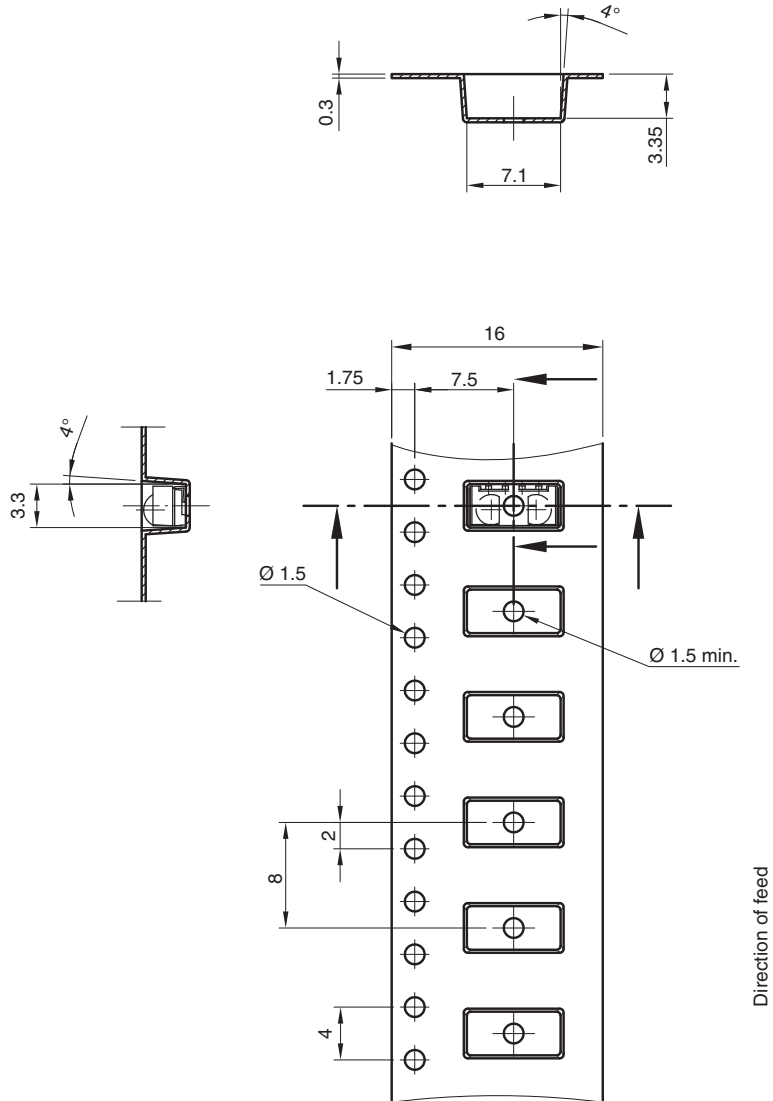
TAPING VERSION TSOP..TR DIMENSIONS in millimeters



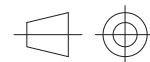
Drawing-No.: 9.700-5337.01-4
 Issue: 1; 16.10.08
 21577



TAPING VERSION TSOP..TT DIMENSIONS in millimeters



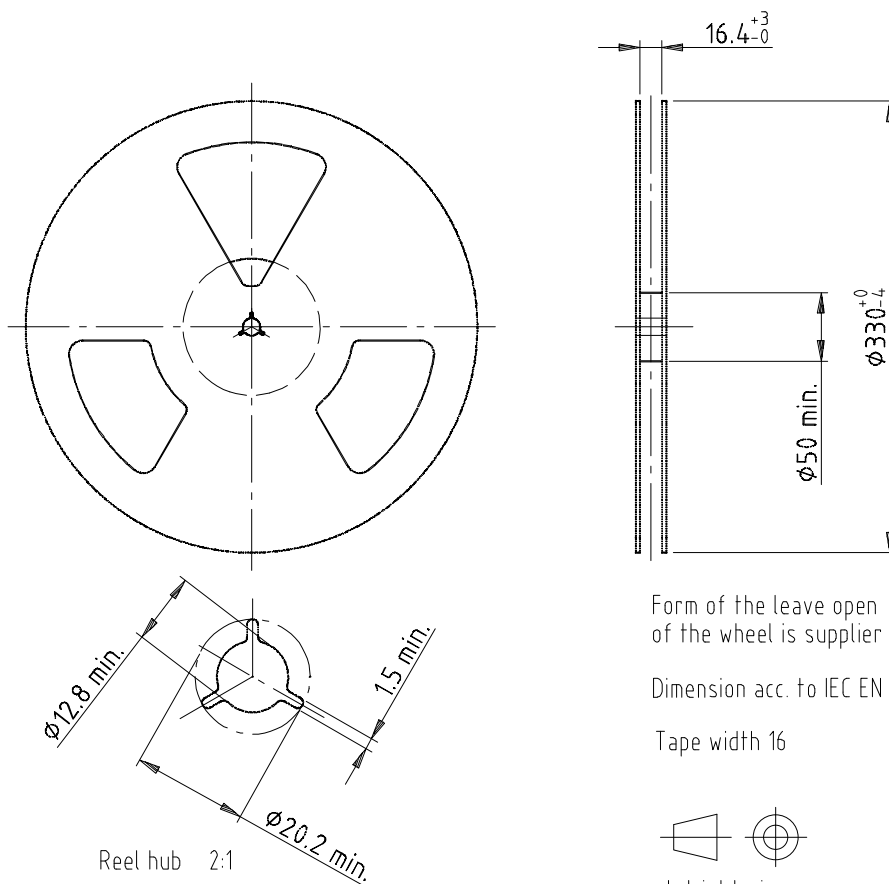
Drawing-No.: 9.700-5338.01-4
Issue: 3; 09.06.09
21578



technical drawings
according to DIN
specifications



REEL DIMENSIONS in millimeters



Reel hub 2:1

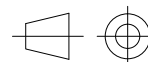
Drawing-No.: 9.800-5052.V2-4
Issue: 1; 07.05.02

16734

Form of the leave open of the wheel is supplier specific.

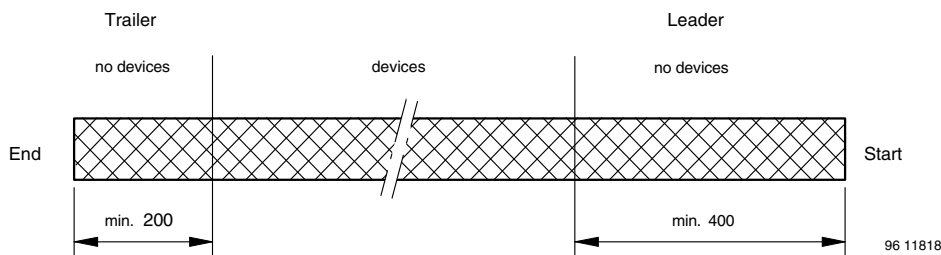
Dimension acc. to IEC EN 60 286-3

Tape width 16



technical drawings according to DIN specifications

LEADER AND TRAILER DIMENSIONS in millimeters



96 11818

COVER TAPE REEL STRENGTH

According to DIN EN 60286-3

0.1 N to 1.3 N

300 ± 10 mm/min.

165° to 180° peel angle

LABEL

Standard bar code labels for finished goods

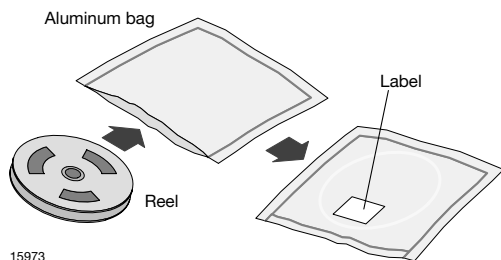
The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.



VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL (finished goods)		
PLAIN WRITING	ABBREVIATION	LENGTH
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	xxxxxxx+	Company logo
LONG BAR CODE TOP	TYPE	LENGTH
Item-number	N	8
Plant-code	N	2
Sequence-number	X	3
Quantity	N	8
Total length	-	21
SHORT BAR CODE BOTTOM	TYPE	LENGTH
Selection-code	X	3
Data-code	N	3
Batch-number	X	10
Filter	-	1
Total length	-	17

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

RECOMMENDED METHOD OF STORAGE

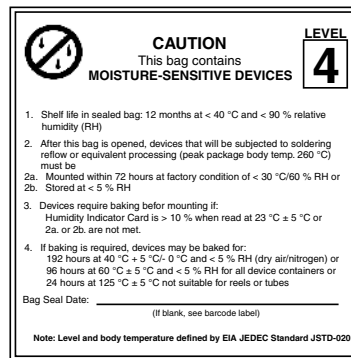
Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:
 192 h at 40 °C + 5 °C/- 0 °C and < 5 % RH (dry air/nitrogen) or
 96 h at 60 °C + 5 °C and < 5 % RH for all device containers or
 24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC standard JSTD-020 level 4 label is included on all dry bags.



EIA JEDEC standard JSTD-020 level 4 label is included on all dry bags



ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electro-static sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS (example)

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



22178



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